

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

application of

Confirmation No. 9620

Masanobu NOGOME et al.

Docket No. 2003_1075A

Serial No. 10/630,900

Group Art Unit 2818

Filed July 31, 2003

Examiner Mai Huong Tran

SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF

AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

THE COMMISSIONER IS AUTHORIZED TO CHARGE ANY DEFICIENCY IN THE FEES FOR THIS PAPER TO DEPOSIT ACCOUNT NO. 23-0975

Sir:

Responsive to the Office Action dated March 22, 2005, please amend the above-identified application as follows.

AMENDMENT TO THE TITLE

Please replace the original title with following rewritten title.

"Semiconductor Device Including a Photosensitive Resin Covering at Least a Portion of a Substrate Having a Via Hole"

a.a. 1991年 2011年 (1886年) 11年 (1886年) (188